

The relevant nomenclature for the tabulated thermal information supplied in this section for the Maxi, Mini, and Micro modules is defined as follows:

T_b = baseplate temperature

T_a = ambient temperature

P_{out} = module output power

P_{in} = module input power

η = module efficiency = P_{out} / P_{in}

P_{diss} = module power dissipation = $P_{in} - P_{out} = (1/\eta - 1) \cdot P_{out}$

Supplied thermal resistance values:

θ_{bs} = baseplate-to-heatsink thermal resistance

θ_{ba} = baseplate-to-ambient thermal resistance

Basis of output power versus ambient temperature derating curves:

$$(T_a)_{max} = (T_b)_{max} - \theta_{ba} \cdot P_{diss} = (T_b)_{max} - \theta_{ba} \cdot (1/\eta - 1) \cdot P_{out}$$

Additional Thermal Data

The following pages contain temperature derating curves.
For additional thermal data, see the following link:

www.vicorpower.com/support/technical/apps-info/xls/calc_t~1.xls

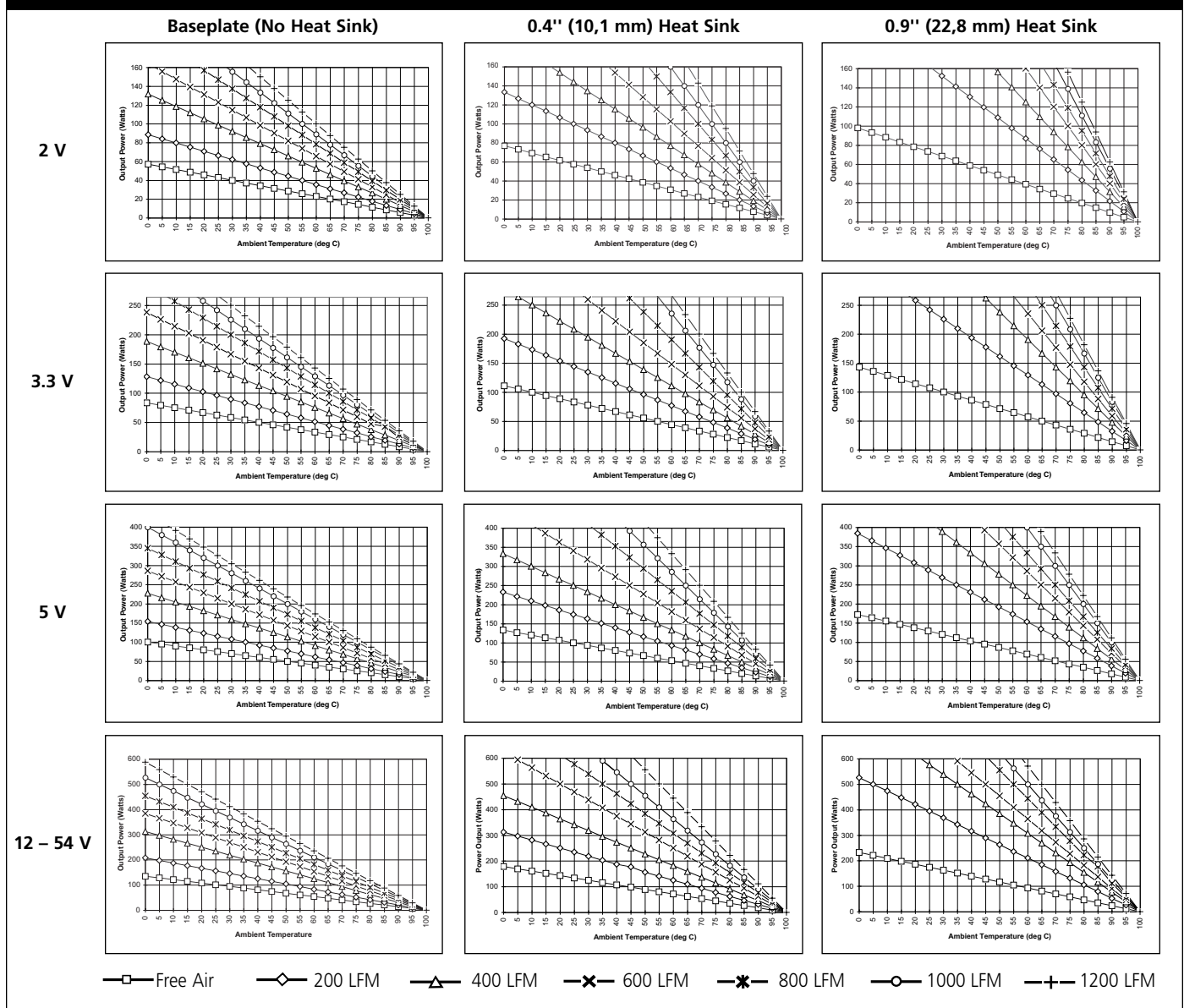
THERMAL PERFORMANCE CURVES (Maxi)

Table Usage: The forced convection thermal impedance data shown in the tables on the next three pages assumes airflow through the heat sink fins. Actual airflow through the fins should be verified. For purposes of heat sink calculation, assume efficiencies listed on Maxi data sheets. Use as a design guide only. Verify final design by actual temperature measurement.

Maxi θ_{ba} (Baseplate-to-Ambient Thermal Resistance Values) vs. Airflow

$\theta_{bs} = 0.07\text{ }^{\circ}\text{C/W}$	Baseplate	0.9" Longitudinal Fins	0.9" Transverse Fins	0.4" Longitudinal Fins	0.4" Transverse Fins
Free Air	4.98	2.89	2.24	3.72	3.49
200 LFM	3.23	1.30	1.02	2.14	1.53
400 LFM	2.17	0.90	0.72	1.48	1.08
600 LFM	1.73	0.72	0.60	1.10	0.87
800 LFM	1.46	0.59	0.51	0.86	0.70
1,000 LFM	1.27	0.51	0.44	0.71	0.60
1,200 LFM	1.14	0.46	0.41	0.61	0.55

Maxi Output Power vs. Ambient Temperature Derating Curves



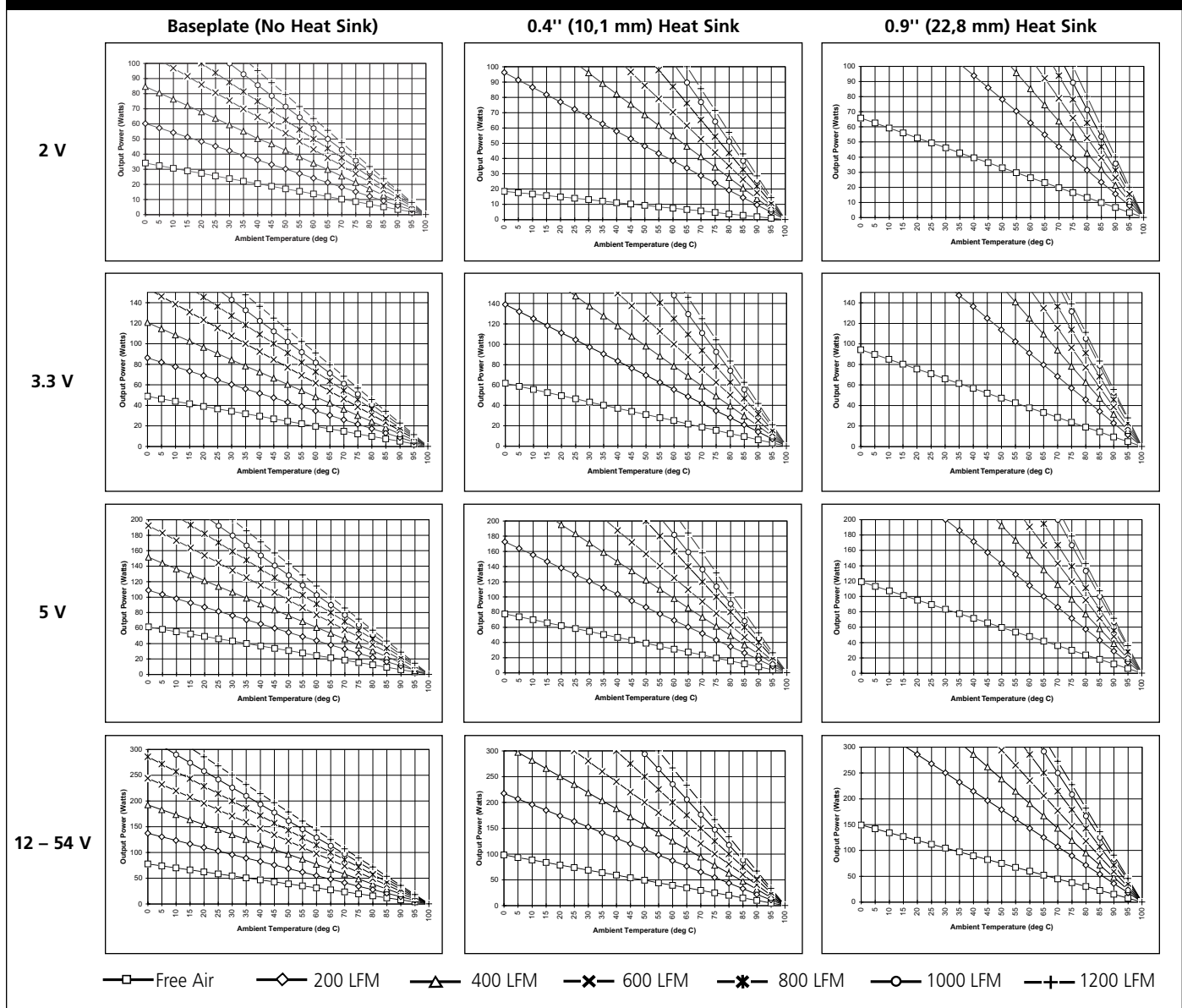
THERMAL PERFORMANCE CURVES (Mini)

Table Usage: The forced convection thermal impedance data shown in the tables on the next three pages assumes airflow through the heat sink fins. Actual airflow through the fins should be verified. For purposes of heat sink calculation, assume efficiencies listed on Mini data sheets. Use as a design guide only. Verify final design by actual temperature measurement.

Mini θ_{ba} (Baseplate-to-Ambient Thermal Resistance Values) vs. Airflow

$\theta_{bs} = 0.14\text{ }^{\circ}\text{C/W}$	Baseplate	0.9" Longitudinal Fins	0.9" Transverse Fins	0.4" Longitudinal Fins	0.4" Transverse Fins
Free Air	7.94	4.10	3.93	6.28	6.34
200 LFM	4.50	1.72	1.93	2.81	3.00
400 LFM	3.20	1.26	1.38	1.98	2.09
600 LFM	2.52	1.02	1.06	1.55	1.59
800 LFM	2.15	0.86	0.89	1.24	1.31
1,000 LFM	1.89	0.75	0.77	1.05	1.11
1,200 LFM	1.69	0.68	0.70	0.94	0.99

Mini Output Power vs. Ambient Temperature Derating Curves



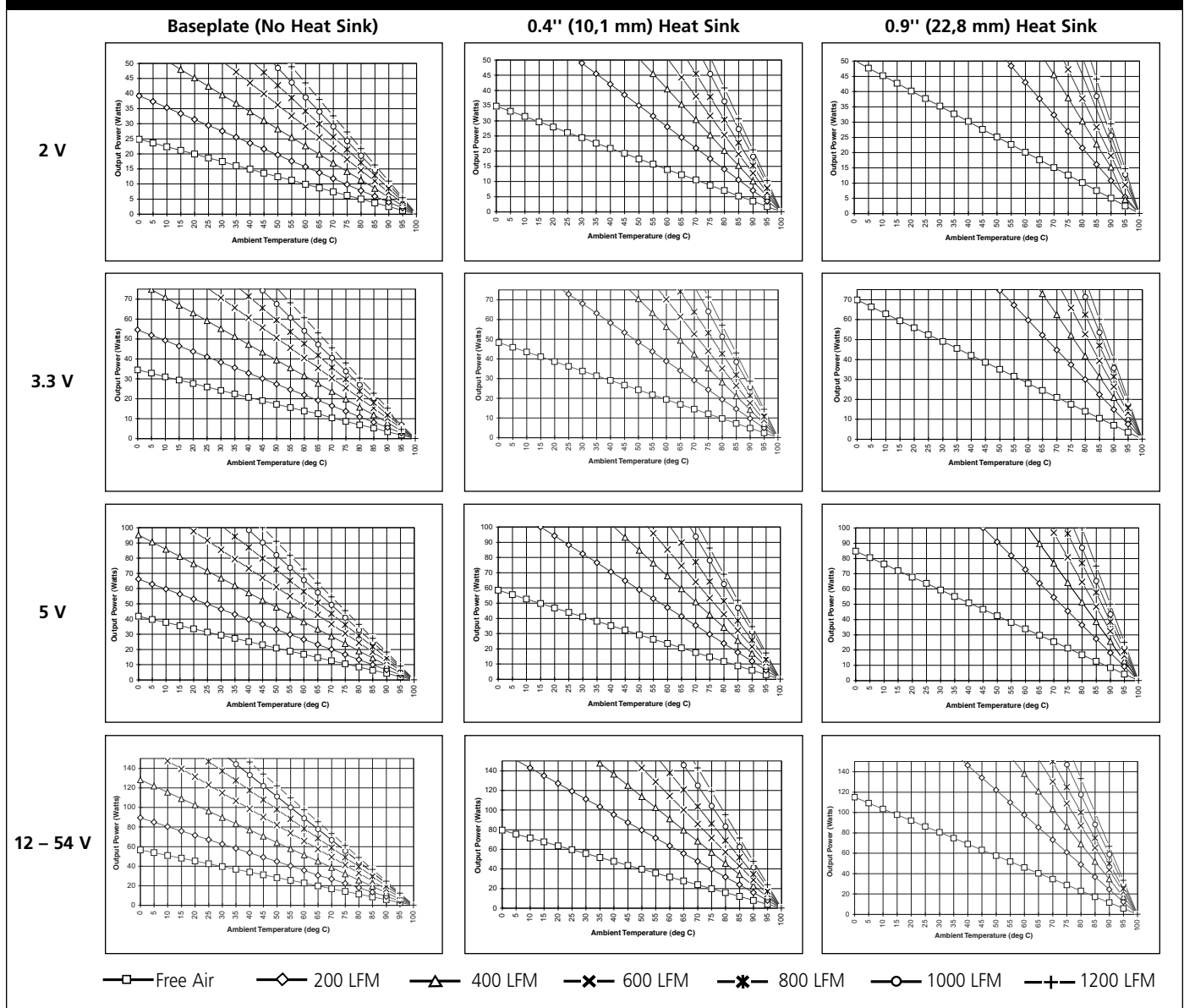
THERMAL PERFORMANCE CURVES (Micro)

Table Usage: The forced convection thermal impedance data shown in the tables on the next three pages assumes airflow through the heat sink fins. Actual airflow through the fins should be verified. For purposes of heat sink calculation, assume efficiencies listed on Micro data sheets. Use as a design guide only. Verify final design by actual temperature measurement.

Micro θ_{ba} (Baseplate-to-Ambient Thermal Resistance Values) vs. Airflow

$\theta_{bs} = 0.21\text{ }^{\circ}\text{C/W}$	Baseplate	0.9" Longitudinal Fins	0.9" Transverse Fins	0.4" Longitudinal Fins	0.4" Transverse Fins
Free Air	10.90	5.37	5.04	7.77	7.76
200 LFM	6.90	2.51	2.31	3.87	3.58
400 LFM	4.78	1.79	1.68	2.68	2.52
600 LFM	3.74	1.42	1.31	2.13	2.01
800 LFM	3.15	1.20	1.10	1.78	1.67
1,000 LFM	2.79	1.06	0.97	1.48	1.45
1,200 LFM	2.49	0.93	0.88	1.32	1.29

Micro Output Power vs. Ambient Temperature Derating Curves



Typical Examples — Thermal Equations (Maxi, Mini, Micro)

EXAMPLE 1

Determine the maximum output power for a Maxi module without a heat sink delivering 5 V in 400 LFM airflow at a maximum ambient temperature of 40°C.

$$\text{Maximum output power} = (T_{b_{\max}} - T_{a_{\max}}) / [\theta_{ba} \cdot (1/\eta - 1)]$$

$$T_{b_{\max}} = 100^{\circ}\text{C}$$

$$T_{a_{\max}} = 40^{\circ}\text{C}$$

For Maxi module without a heat sink @ 400 LFM, $\theta_{ba} = 2.17^{\circ}\text{C/W}$

For the 5 V Maxi module the typical value for $\eta = 0.83$

$$\text{Maximum output power} = (100 - 40) / [2.17 (1/0.83 - 1)] \sim 135 \text{ W}$$

Or, the same answer could be obtained by using the output power versus ambient temperature derating curves for the Maxi modules.

For the case with no heat sink the baseplate chart for the 5 V module would be used. At a 40°C ambient and 400 LFM airflow this chart indicates a maximum output power of approximately 135 W.

For full output power of 400 W the required thermal resistance is;

$$\theta_{ba} = (100 - 40) / [400 (1/0.83 - 1)] = 0.73^{\circ}\text{C/W}$$

What size heat sink would be necessary to operate at full output power (400 W) under the same conditions?

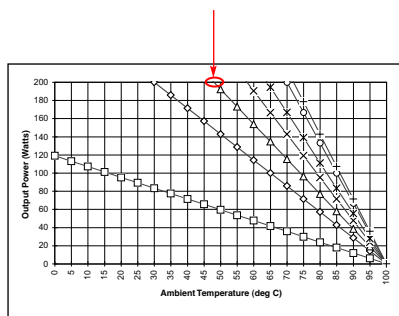
From the θ_{ba} versus airflow charts for the Maxi, the thermal resistance at 400 LFM airflow requires the use of a 0.9" (22,8 mm) transverse fin heat sink.

EXAMPLE 2

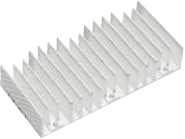
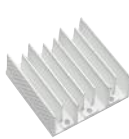
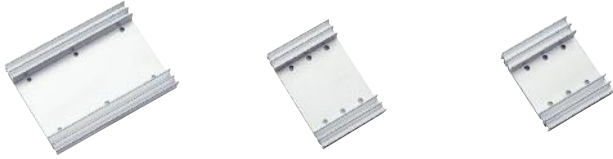
Determine the maximum ambient for a Mini module with a 0.9" (22,8 mm) heat sink in 400 LFM of airflow delivering 200 W at 5 V.

From the output power versus ambient temperature chart for the 5 Vout Mini with a 0.9" (22,8 mm) heat sink, the 200 W at 400 LFM data point results in a $T_{a_{\max}}$ of approximately 48°C.

5 V Mini with
0.9" (22,8 mm)
heat sink



THERMAL MANAGEMENT ACCESSORIES (All parts are RoHS compliant unless otherwise noted)

Maxi Heat Sinks			Mini Heat Sinks		Micro Heat Sinks	
Longitudinal Fins	Threaded	Through Hole	Threaded	Through Hole	Threaded	Through Hole
						
	0.4" (10,1 mm) Fin P/N 30482 0.9" (22,8 mm) Fin P/N 30188	0.4" (10,1 mm) Fin P/N 30718 0.9" (22,8 mm) Fin P/N 30181	0.4" (10,1 mm) Fin P/N 32188 0.9" (22,8 mm) Fin P/N 30189	0.4" (10,1 mm) Fin P/N 30195 0.9" (22,8 mm) Fin P/N 30182	0.4" (10,1 mm) Fin P/N 32174 0.9" (22,8 mm) Fin P/N 30190	0.4" (10,1 mm) Fin P/N 30719 0.9" (22,8 mm) Fin P/N 30183
Transverse Fins						
	0.4" (10,1 mm) Fin P/N 30778 0.9" (22,8 mm) Fin P/N 30196	0.4" (10,1 mm) Fin P/N 30720 0.9" (22,8 mm) Fin P/N 30723	0.4" (10,1 mm) Fin P/N 30184 0.9" (22,8 mm) Fin P/N 30269	0.4" (10,1 mm) Fin P/N 30721 0.9" (22,8 mm) Fin P/N 30724	0.4" (10,1 mm) Fin P/N 32173 0.9" (22,8 mm) Fin P/N 30270	0.4" (10,1 mm) Fin P/N 30722 0.9" (22,8 mm) Fin P/N 30725
Low-profile Side-fin Heat Sinks				Standoffs and Screws		
Height only 0.125" (3,17 mm) above module baseplate*				Bulk and single-module kits compatible with all standard mounting configurations.		
 0.55" (13,97 mm) Side Fins P/N 30096 0.55" (13,97 mm) Side Fins P/N 32190 0.55" (13,97 mm) Side Fins P/N 30095 <i>Not compatible with standoff kits.</i>				 See the following link for complete info: www.vicorpower.com/products/accessories/2nd_gen_standoffs/		
ThermMate Thermal Pads						
			For use with Vicor modules, ThermMate thermal pads are a "dry" alternative to thermal compound and are pre-cut to the outline dimensions of the module.			
THERMAL PAD		PART NUMBER		THICKNESS		
Maxi (10 pc. pkg.)		20263		0.007" (0,177 mm)		
Mini (10 pc. pkg.)		20264		0.007" (0,177 mm)		
Micro (10 pc. pkg.)		20265		0.007" (0,177 mm)		

* For thermal curves of low-profile side-fin heat sinks and on-line capability for thermal curve calculations, see the following link:
http://www.vicorpower.com/technical_library/calculators/calc_t~1.xls